Datasheet revision 1.1 <u>www.chipquik.com</u>

# Tack Flux No-Clean for Lead Free in Jar 75g

## **Product Highlights**

Ideal for all rework, solder, de-solder and reflow applications

Non-corrosive, non-conductive, no-clean

Tack flux will not run all over PCB when applied

Has a pleasant odor

Excellent wetting

Easily cleaned with isopropyl alcohol (IPA)

Attachment of BGA spheres

Soldering flip chip components

Long stencil life

Wide process window

Clear residue

Designed for Lead-Free applications

RoHS II and REACH compliant

#### **Specifications**

Flux Type: Synthetic No-Clean (for Lead-Free applications)

Flux Classification: REL0 Packaging: Jar 75g

Shelf Life: Refrigerated >24 months, Unrefrigerated >24 months

#### **Stencil Life**

>8 hours @ 20-50% RH 22-28°C (72-82°F) >4 hours @ 50-70% RH 22-28°C (72-82°F)

#### Stencil Cleaning

Automated stencil cleaning systems for both stencil and misprinted boards. Manual cleaning using isopropyl alcohol (IPA).

#### Storage and Handling

Store refrigerated or at room temperature 3-25°C (37-77°F). Do not freeze. Allow 4 hours for flux to reach an operating temperature of 20-25°C (68-77°F) before use.

### **Transportation**

This product has no shipping restrictions. Shipping below 0°C (32°F) or above 25°C (77°F) for normal transit times by ground or air will not impact this product's stated shelf life.

## **Conforms to the following Industry Standards:**

J-STD-004B, Amendment 1 (Solder Fluxes):

RoHS 2 Directive 2011/65/EU:

Yes

Yes